Transistors Panasonic

2SC5848

Silicon NPN epitaxial planar type

For general amplification Complementary to 2SA2079

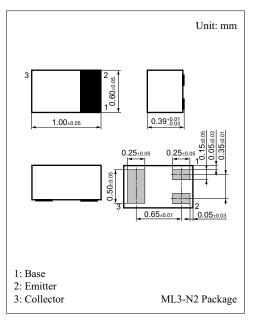
■ Features

- High forward current transfer ratio h_{FE}
- Suitable for high-density mounting and douwsizing of the equipment for ultraminiature leadless package

Package: $0.6 \text{ mm} \times 1.0 \text{ mm}$ (hight 0.39 mm)

■ Absolute Maximum Ratings $T_a = 25$ °C

| Parameter | Symbol | Rating | Unit | |
|---------------------------------------|------------------|-------------|------|--|
| Collector-base voltage (Emitter open) | V _{CBO} | 60 | V | |
| Collector-emitter voltage (Base open) | V _{CEO} | 50 | V | |
| Emitter-base voltage (Collector open) | V _{EBO} | 7 | V | |
| Collector current | I_{C} | 100 | mA | |
| Peak collector current | I _{CP} | 200 | mA | |
| Collector power dissipation | P _C | 100 | mW | |
| Junction temperature | T _j | 125 | °C | |
| Storage temperature | T _{stg} | -55 to +125 | °C | |



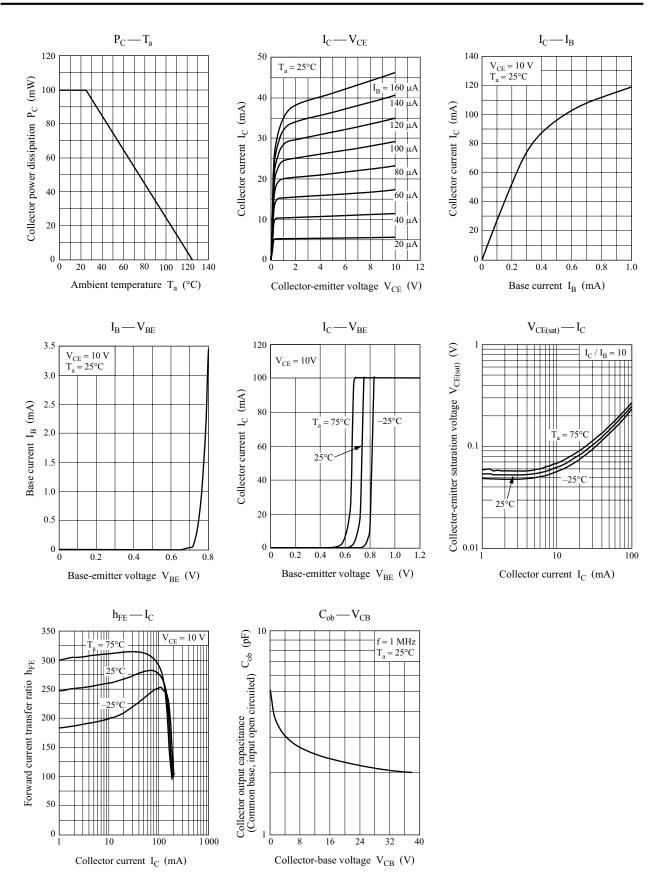
Marking Symbol: 3E

■ Electrical Characteristics $T_a = 25$ °C±3°C

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--|----------------------|---|-----|-----|-----|------|
| Collector-base voltage (Emitter open) | V _{CBO} | $I_{\rm C} = 10 \mu A, I_{\rm E} = 0$ | 60 | | | V |
| Collector-emitter voltage (Base open) | V _{CEO} | $I_C = 2 \text{ mA}, I_B = 0$ | 50 | | | V |
| Emitter-base voltage (Collector open) | V_{EBO} | $I_E = 10 \mu A, I_C = 0$ | 7 | | | V |
| Collector-base cutoff current (Emitter open) | I_{CBO} | $V_{CB} = 20 \text{ V}, I_{E} = 0$ | | | 0.1 | μА |
| Collector-emitter cut-off current (Base open) | I _{CEO} | $V_{CE} = 10 \text{ V}, I_{B} = 0$ | | | 100 | μА |
| Forward current transfer ratio | h_{FE} | $V_{CE} = 10 \text{ V}, I_{C} = 2 \text{ mA}$ | 180 | | 390 | _ |
| Collector-emitter saturation voltage | V _{CE(sat)} | $I_C = 100 \text{ mA}, I_B = 10 \text{ mA}$ | | 0.1 | 0.3 | V |
| Transition frequency | f_T | $V_{CB} = 10 \text{ V}, I_{E} = -2 \text{ mA}, f = 200 \text{ MHz}$ | | 100 | | MHz |
| Collector output capacitance (Common base, input open circuited) | C _{ob} | $V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$ | | 2.2 | | pF |

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

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